

L Number	Hits	Search Text	DB	Time stamp
1	391	self adj assembled adj monolayer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 17:52
8	156420	pyridine pyridinium	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 17:52
15	79	(self adj assembled adj monolayer) and (pyridine pyridinium)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 17:52
22	55	((self adj assembled adj monolayer) and (pyridine pyridinium)) and (semiconductor silicon Si)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 18:34
29	99	linford.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 18:35
36	4	(matthew and linford).in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 18:48
43	5	5429708.URPN.	USPAT	2002/07/17 18:42
44	1251102	(silicon si) near5 bond\$3 (organic molecule molecules)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 18:53
51	1488851	(silicon si) near5 bond\$3 (organic molecule molecules molecular)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:01
58	198231	(silicon si) near2 (surface substrate wafer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:01
65	9555	(silicon si) near8 (bonded bonding bond bonds) near8 (organic molecule molecules molecular)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:13
72	896	((silicon si) near2 (surface substrate wafer)) and ((silicon si) near8 (bonded bonding bond bonds) near8 (organic molecule molecules molecular))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:14
79	143	((silicon si) near2 (surface substrate wafer)) and ((silicon si) near8 (bonded bonding bond bonds) near8 (organic molecule molecules molecular)) and barrier	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:02

86	26	((silicon si) near8 (bonded bonding bond bonds) near8 (organic molecule molecules molecular)) same barrier	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:03
93	422	(silicon si) near8 ((chemical chemically molecular molecularly covalent covalently) near1 (bonded bonding bond bonds)) near8 (organic molecule molecules molecular)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:16
100	130	((silicon si) near2 (surface substrate wafer)) and ((silicon si) near8 ((chemical chemically molecular molecularly covalent covalently) near1 (bonded bonding bond bonds)) near8 (organic molecule molecules molecular))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:17
107	223	(silicon si) near8 ((chemical chemically molecular molecularly covalent covalently) near1 (bonded bonding bond bonds)) near8 (organic organo)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:16
114	49	((silicon si) near2 (surface substrate wafer)) and ((silicon si) near8 ((chemical chemically molecular molecularly covalent covalently) near1 (bonded bonding bond bonds)) near8 (organic organo))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/17 19:17
121	0	5770266.URPN.	USPAT	2002/07/17 19:22
122	0	5770266.URPN.	USPAT	2002/07/17 19:23
123	4	5468551.URPN.	USPAT	2002/07/17 19:23
124	4	5849369.URPN.	USPAT	2002/07/17 19:24
125	2	5907013.URPN.	USPAT	2002/07/17 19:25
126	2	5907013.URPN.	USPAT	2002/07/17 19:26
127	0	6280517.URPN.	USPAT	2002/07/17 19:26
128	0	6060123.URPN.	USPAT	2002/07/17 19:26
129	0	6060123.URPN.	USPAT	2002/07/17 19:26